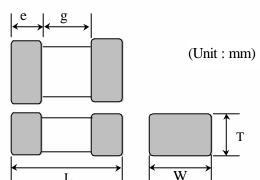
Specification Sheet

< Chip Monolithic Ceramic Capacitor>

Murata Global P/N: GRM32ER61C226KE20L (1210,X5R,22uF,16V)



| L | L W | | e | g | |
|-----------|-----------|-----------|----------|----------|--|
| 3.2+/-0.3 | 2.5+/-0.2 | 2.5+/-0.2 | 0.3 min. | 1.0 min. | |



Rated Value

| TC code | TC | DC Rated | CAI | Ρ. | CAP.TOL |
|---------|-----|-------------|-----|----|---------|
| | | Voltage (V) | | | |
| R6 | X5R | 16 | 22 | uF | +/-10% |

Packaging

| Specification | Packaging unit | | | |
|------------------------------------|----------------|--|--|--|
| | [pcs/reel] | | | |
| 178 Plastic Tape Carrier Packaging | 1000 | | | |

Specification

Please refer to next page.

Notice>

- (1) This specification sheet is applied for CHIP MONOLITHIC CERAMIC CAPCITOR used for General Electronics equipment for your design.
- (2) Please contact our sales representative or product engineers before using our products for the application listed below which require of our products for other applications than specified in this products.
 - (1) Aircraft equipment (2) Aerospace equipment (3) Undersea equipment (4) Medical equipment
 - (5) Transportation equipment (6) Traffic signal equipment (7) Disaster prevention / crime prevention equipment
 - (8) Application of similar complexity and/or requirements to the applications listed in the above.
- (3) Please do not use this specification sheet for quality contract.

If you need to exchange quality contract, please request us to provide the full product specification (including part number construction, available capacitance range, packaging and caution notes) for approval.

Product Engineering Department Monolithic Ceramic Capacitor Group FUKUI MURATA MFG. CO., LTD.

| | | SPECIFICATION S AND TEST METH | HOD | S | | P 1 | 1 | |
|-----|----------------------------------|--|--|---|---|--|--|--|
| No | Item | Specification | | Te | est Method | | | |
| 1 | 3 | R6: -55°C to +85°C R7/ C7: -55°C to +125°C F5: -30°C to +85°C C8: -55°C to +105C | | | | | | |
| 2 | Rated Voltage | See the previous pages. | The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V ^{P-P} or V ^{OP} , whichever is larger, shall be maintained within the rated voltage range. | | | | | |
| | Appearance | No defects or abnormalities. | Visua | al inspection. | | | | |
| _ | Dimensions | Within the specified dimension. | | g calipers. | | | | |
| | _ | No defects or abnormalities. | appli char | ailure shall be observed ed between the terminatio ge/discharge current is les | ns for 1 to 5 is than 50mA | seconds, ¡ \. | provided the | |
| | Insulation Resistance | 50Ω· F min. | exce | nsulation resistance shall eding the rated voltage at tes of charging. | 25 °C and 75 | %RH max | and within 1 | |
| 7 | Capacitance | Within the specified tolerance. | | capacitance/D.F. shall be r roltage shown in the table | | 25 °C at th | ne frequency | |
| 8 | | R6 / R7 / C7/ C8 : 0.1 max. F5: 0.2 max. | | | Frequency 1± 0.1kHz | | Voltage 1.0 ± 0.2 Vrms | |
| | | | | C _≤ 10μF (6.3V max.) | 1± 0.1kHz | 0.5 | ± 0.1 Vrms | |
| | | | | C > 10µF | 120± 24Hz | 0.5 | ± 0.1 Vrms | |
| | | | * Measuring Voltage : 0.5 ±0.1Vrms GRM155R61A124~224KE19 GRM185R61A105KE26 GRM188R61A225KE19 GRM219R61A475KE19 | | | | | |
| 9 | Capacitance | Char. Temp.Range Referenc Cap.Change | | capacitance change shall | oe measured | affter 5 m | nin.at each | |
| | Temperature Characteristics | e Temp. | specified temperature stage. The ranges of capacitance change compared with the 25 °C value over the temperature ranges shown in the table shall be within the | | | | | |
| | | R6 -55°C to +85°C 25°C Within ±15% R7 -55°C to +125°C 25°C Within ±15% | | | | | | |
| | | F5 -30°C to +85°C 25°C Within+22/-82% | | ified ranges. | 0.1/4.4.000/4 | 70 . 4 0 . / | 0.0)/**** | |
| | | C7 -55°C to +125°C 25°C Within ±22% | Measuring Voltage : GRM43 R6 0J/1A 336/476 : 1.0+/-0.2Vrms | | | | | |
| | | C8 -55°C to +105°C 25°C Within ±22% | | | | | | |
| 10 | Adhesive Strength of Termination | No removal of the terminations or other defects shall occur. Solder resist Baked electrode or copper foil | using test ji or us | er the capacitor to the test g a eutectic solder. Then a ig for 10±1 sec. The solde ing the reflow method and he soldering is uniform ar *5N (GR □15, G Type a GR □03 0.3 GR □15 0.4 GRM18 1.0 GRM21 1.2 GRM31 2.2 GRM32 2.2 GRM32 3.5 | pply *10N fo ring shall be d shall be cor d free of def | rce in para done eithe nducted w ects such | allel with the er with an iron rith care so | |
| | | | | GRM55 4.5 | 8.0 | 5.6 | | |
| 111 | Vibration | Appearance No defects or abnormalities. Capacitance Within the specified tolerance. D.F R6/R7/C7/C8: 0.1 max. F5: 0.2 max. | the sicapa- total betw from appro | er the capacitor to the test ame manner and under th citor shall be subjected to amplitude of 1.5mm, t een the approximate limits 10 to 55Hz and retu oximately 1 minute. motion shall be applied for tually perpendicular direct | e same cond a simple harm ne frequence of 10 and 55 irn to 10Hz | itions as (inonic moting being 5Hz. The standard | 10). The on having a varied uniformly frequency range, be traversed in | |

| | | SPECII | FICATIONS AND TEST METH | HODS | | | P 2 | | |
|----|------------------------------|------------------------|--|--|--|---------------------|---|-----------------------|--|
| No | Item | | Specification | | Test | Method | | | |
| 12 | Deflection | No cracking | or marking defects shal occur. 20 50 Pressunzing speed:1.0mm/sec. Pressunze | Solder the capacitor to the test jig (glass epoxy board) shown in Figusing a eutectic solder. Then apply a force in the direction shown i Fig.3. The soldering shall be done either with an iron or using the reflow method and shall be conducted with care so that the solderi is uniformand free of defects such as heat shock. | | | | | |
| | | K230- | | | Туре | a | a b | С | |
| | | | " | | GR □03 | 0. | | 0.3 | |
| | | Can | ∽2∕— om ─ │ Flexure ≦¹ aditance meter | | GR□15 | 0. | | 0.5 | |
| | | 45 | · · · · · · · · · · · · · · · · · · · | | GRM18 | 1. | | 1.2 | |
| | | ı | Fin 2 | φ4.5 ———————————————————————————————————— | GRM21 GRM31 | 2. | | 1.65 2.0 | |
| | | | Fig.3 | | GRM32 | 2 | | 2.9 | |
| | | | | * | GRM43 | 3. | 5 7.0 | 3.7 | |
| | | | 100 | | GRM55 | 4. | 5 8.0 | 5.6 | |
| | | | Fig.2 | t : 1.6mm | | | (in:mm) | | |
| | Solderability of Termination | and continuo | | Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion). Preheat at 80 to 120 °C for 10 to 30 seconds. After preheating, immerse in eutectic solder solution for 2 ± 0.5 seconds at 230 ± 5 °C. | | | | | |
| 14 | Resistance to Soldering Heat | | No marking defects. | Preheat the capacitor the capacitor in a eut | | | | | |
| | to Soldering Heat | Change | R6/R7/C7/C8: Within ±7.5% F5: Within ±20% | seconds. Let sit at ro | | | | 101 10 ±0.5 | |
| | | D.F. | R6/R7/C7/C8: 0.1 max. F5: 0.2 max. | Initial measurement Perform a heat treatment at 150 ± $^0_{10}$ °C for one hour and | | | | | |
| | | I.R. | 50Ω·F min. | then let sit for 48 ±4 | hours at roo | om temp | erature. Perfo | rm | |
| | | Dielectric Strength | No failure | the initial measurement. | | | | | |
| 15 | Temperature | | No marking defects. | Fix the capacitor to the | | | | | |
| | Sudden Change | Change | R6/R7/C7/C8 : Within ±7.5% F5: Within ±20% | and under the same of according to the four | heat treatme | ents liste | d in the | | |
| | | D.F. | R6/R7/C7/C8: 0.1 max. F5: 0.2 max. | following table. Let si then measure. | IL IUI 40 ±4 I | iouis at | ioom tempera | iure, | |
| | | I.R. | 50Ω·F min. | Step | 1 | 2 | 3 | 4 | |
| | | Dialoctrio No failuro | | Temp.(°C) | Min. Operating Femp. $\pm \frac{0}{3}$ | Room Temp. | Max. Operating Temp.± $\frac{3}{0}$ | Room Temp. | |
| | | Dielectric Strength | No failure | Time(min.) | 30±3 | 2 to 3 | 30±3 | 2 to 3 | |
| | | _ | | Initial measurement Perform a heat trea then let sit for 48 ± measurement. | atment at 150 4 hours at ro | 0 ± 0°C oom temp | for one hour perature. Perfo | and ormthe initial | |
| 16 | High Temperature | | No marking defects. | Apply the rated voltage at 40 \pm 2 °C and 90 to 95% hu 500 \pm 12hours. | | | | nidityfor | |
| | High Humidity | Capacitance Change | R6/R7/C7/C8: Within $\pm 12.5\%$ F5: Within $\pm 30\%$ | The charge/discharge | | | | | |
| | (Steady) | D.F. | R6/R7/C7/C8: 0.2max. F5: 0.4max. | Initial measurement Perform a heat treatment at 150 $\pm \frac{0}{10}$ °C for one hour and then let sit for 48 ± 4 hours at room temperature. Perform | | | | | |
| | | I.R. | 12.5 Ω ·F min. | the initial measureme | ent. | | | | |
| | | Dielectric Strength | No failure | Measurement after the Perform a heat treat then let sit for 48 ±4 | tment at 150 | | | | |
| 17 | Durability | Appearance | No marking defects. | Apply 150% of the rated voltage for 1000 \pm 12 hours at the maximum operating temperature \pm 3°C. | | | the | | |
| | , | Capacitance Change | R6/R7/C7/C8: Within ±12.5% F5: Within ±30% | The charge/ discharg | | | n 50mA. | | |
| | | D.F. | R6/R7/C7/C8: 0.2max. F5: 0.4max. | · Initial measurement Perform a heat treat | | | | | |
| | | I.R. | 25Ω·F min. | then let sit for 48 ±4 the initial measurem | ent. | om temp | erature. Perfo | rm | |
| | | Dielectric Strength | No failure | Measurement after the Perform a heat treath then let sit for 48 ±4 | tment at 150 | | | | |